APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-45°C TO +125°C(NOTES 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C(NOTE2)
	VOLTAGE	150V AC	APPLICABLE CONNECTOR	DF9#－*P－1V(22)
	CURRENT	0.5A		DF9#－*P－1V(32)

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	100m A (DC OR 1000 Hz).	50mΩ MAX.	X	—
INSULATION RESISTANCE	100V DC.	500MΩ MIN.	X	—
VOLTAGE PROOF	250V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	30TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 50mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
SHOCK	490 m/s^2 DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
ENVIRONMENTAL CHARACTERISTICS				
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -65→ 5 TO 35→125→ 5 TO 35°C TIME 30→10 TO 15→ 30→10TO15min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
HEAT RESISTANCE OF SOLDERING	【RECOMMENDED TEMPERATURE PROFILE】 《SOLDERING AREA》 MAX250℃, 220℃ FOR 60 SECONDS MAX. 《PREHEATING AREA》 150 TO 180℃ 90～120 SECONDS. MAXIMUM TWICE ACTION IS ALLOWED UNDER THE SAME CONDITION. 【RECOMMENDED MANUAL SOLDELING CONDITION 】 SOLDERING IRON TEMPERATURE 380℃ SOLDERING TIME : WITHIN 3 SECONDS.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY	SOLDERING TEMPARATURE:245±5℃ DURATION OF IMMERSION : SOLDERING FOR 3SECONDS	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.	X	—
△2				

REMARKS
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT.
NOTE2:STORAGEIS DEFINED AS LONG-TERM STORAGE OF UNUSED PRODUCTS.
APPLY OPERATION TEMPERATURE RANGE TO PRODUCTS MOUNTED ON PCB WITHOUT POWER SUPLLY.

UNLESS OTHERWISE SPECIFIED , REFER TO JIS C 5402 .

	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△2	1	DIS-H-001204	AR.TAKAHASHI	TS.MIYAZAKI	06.08.02

APPROVED	TY.OMA	04.03.31
CHECKED	TS.MIYAZAKI	04.03.31
DESIGNED	HK.UMEHARA	04.03.31
DRAWN	M.NAKAMOTO	04.03.31

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

DRAWING NO. ELC4-162419-11

SPECIFICATION SHEET		PART NO.	DF9-*S-1V(32)	
HIROSE ELECTRIC CO., LTD.		CODE NO.	CL540 △2	1/1

FORM HD0011-2-1